

# 1A, 200V - 1000V Standard Surface Mount Rectifier

### **FEATURES**

- Glass passivated chip junction
- Ideal for automated placement
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- DC to DC converter
- Switching mode converters and inverters
- General purpose

#### **MECHANICAL DATA**

- · Case: Thin SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Pure tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.029g (approximately)

KEY PARAMETERS			
PARAMETER VALUE UN			
l <sub>F</sub>	1	Α	
$V_{RRM}$	200 - 1000	V	
I <sub>FSM</sub>	30	Α	
$T_{JMAX}$	150	°C	
Package	Thin SMA		
Configuration	Single die		









Thin SMA



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)								
PARAMETER		SYMBOL	S1DAL	S1GAL	S1JAL	S1KAL	S1MAL	UNIT
Marking code on the devi	се		S1DAL	S1GAL	S1JAL	S1KAL	S1MAL	
Repetitive peak reverse v	Repetitive peak reverse voltage		200	400	600	800	1000	V
Reverse voltage, total rms value		V <sub>R(RMS)</sub>	140	280	420	560	700	V
Forward current		I <sub>F</sub>	1			Α		
Surge peak forward current single half sine t = 8.3ms		1	30				А	
wave superimposed on rated load	t = 1.0ms	I <sub>FSM</sub>	100			А		
Junction temperature		$T_J$	-55 to +150		°C			
Storage temperature		T <sub>STG</sub>	-55 to +150		°C			



THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	29	°C/W	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	82	°C/W	
Junction-to-case thermal resistance	R <sub>eJC</sub>	30	°C/W	

**Thermal Performance Note:** Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage <sup>(1)</sup>	$I_F = 0.5A, T_J = 25^{\circ}C$		0.90	-	V
	$I_F = 1A, T_J = 25^{\circ}C$	V <sub>F</sub>	0.96	1.10	V
	I <sub>F</sub> = 0.5A, T <sub>J</sub> = 125°C		0.78	-	V
	$I_F = 1A, T_J = 125$ °C		0.85	0.98	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	T <sub>J</sub> = 25°C		-	1	μΑ
	T <sub>J</sub> = 125°C	l <sub>R</sub>	-	50	μA
Junction capacitance	1MHz, $V_R = 4.0V$	CJ	8	-	pF

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING		
S1xAL	Thin SMA	14,000 / Tape & Reel		

### Notes:

1. "x" defines voltage from 200V(S1DAL) to 1000V(S1MAL)



### **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

**Fig.1 Forward Current Derating Curve** 

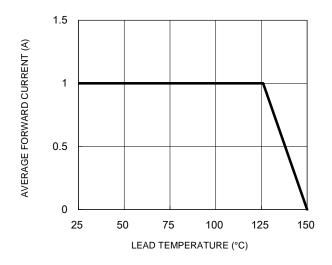


Fig.3 Typical Reverse Characteristics

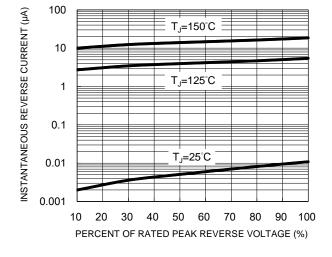


Fig.2 Typical Junction Capacitance

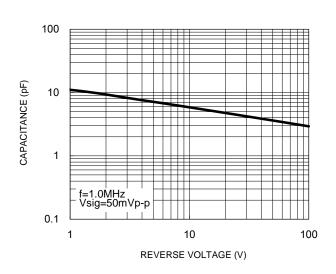


Fig.4 Typical Forward Characteristics

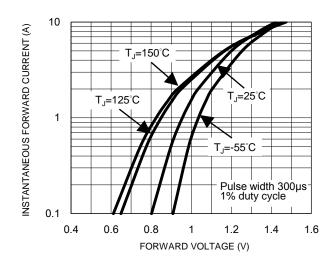
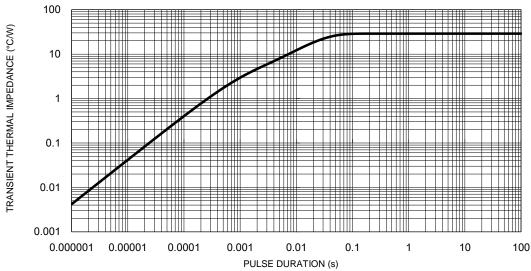


Fig.5 Typical Transient Thermal Impedance



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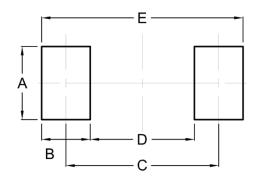


# **PACKAGE OUTLINE DIMENSIONS**

Thin SMA – E1 – С **-** L1

DIM.	Unit (mm)		Unit (inch)	
Dilvi.	Min.	Max.	Min.	Max.
Α	0.90	1.00	0.035	0.039
A1	0.00	0.10	0.000	0.004
b	1.25	1.45	0.049	0.057
С	0.10	0.22	0.004	0.009
D	2.50	2.70	0.098	0.106
E	5.05	5.35	0.199	0.211
E1	4.15	4.35	0.163	0.171
L	0.75	1.20	0.030	0.047
L1	0.30	0.60	0.012	0.024

## **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	2.10	0.083
В	1.40	0.055
С	4.40	0.173
D	3.00	0.118
E	5.80	0.228

# **MARKING DIAGRAM**



P/N = Marking Code YW = Date Code = Factory Code





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